| ASSOCIATION CONNECTING LECTRONICS INDUSTRIES | annockburn, Illinois, A | All rights reserved un ntions. | ider both The | is docume vel parts, th | ent is a declaration ne declaration en | n of the substance compasses all lov | es within the manufactur ver level materials for wl | er listed ite hich the ma | m. Note: if t nufacturer h | he item is an as as engineering | sembly with lower responsibility. | |
|---|---|--------------------------------|----------------|----------------------------|---|--|--|--|-------------------------------|---------------------------------|-----------------------------------|--|
| | IPC Web Site for Information on IPC-1752 Standard Form 7 http://www.ipc.org/IPC-175x Distribution | | | | * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information | | | | | | | |
| Supplier Information | | | | | | | | | | | | |
| ompany name* Company unique ID | | | ID Uniq | | Jnique ID Authority | | | Response Date* | | | | |
| onsemi | mi | | | | | | | 2023-06-08 | | | | |
| Contact Name | Name Title - Contact | | | F | Phone - Contact* | | | | Email - Contact* | | | |
| oduct-Env-Stewards Product Enviro Compliance | | | | NA | | | | Product-Env-Stewards@onsemi.com | | | | |
| Authorized Representative* Title - Representative | | | | Phone - Representative* | | | | Email - Representative* | | | | |
| Product-Env-Stewards Product Enviro Compliance | | | | NA | | | Product-Env-Stewards@onsemi.com | | | | | |
| Requester Item Number N | Ifr Item Number | Mfr Item Name | | | Effective Date | Version | Manufacturing Site | | 'eight* | UOM | Unit Type | |
| N | MC100EP142FAG BBG ECL 9-BI | | SHIFT RGSTR | GSTR 2023- | | | TW2 | | 75.1 | mg | Each | |
| Manufacturing Proccess Information | | | | | | | · | | | | | |
| Terminal Plating / Grid Array Material | Terminal Base | Alloy J- | STD-020 MSL Ra | D-020 MSL Rating | | Peak Process Body Temperature Max Time a | | ak Temperature Number of Reflow Cycles | | | les | |
| Matte Tin (Sn) - annealed CU Alloy 2 | | | | | 260 | С | 30 | second | s 3 | | | |
| Comments | | | | | | | | | | | | |
| ATTENTION: MSL 2 Rated item requires Dry | Pack (after electrical | test) | | | | | | | | | | |
| for more information regarding material comp | osition please refer to | page 3 | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed | | | | |
|--|---|--|---|---|---|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl nthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). | | | | | | | | |
| cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the | henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies | RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform | ce of its products with European Union membe | ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of | | | | |
| RoHS Declaration * 1 - Item(s) | does not contain RoHS restricted substa | ances per the definitio | on above | Supplier Acceptance | * Accepted | | | | |
| Exemption: If the declared item does not con applicable exemptions. | ntain RoHS restricted substances per | the definition above | except for defined RoHS exempti | ons, then select the corresponding response i | n the RoHS Declaration above and choose all | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | |
| Declaration Signature | | | | | | | | | |
| Instructions: Complete all of the required fin Requester) and click on Submit Form to have | elds on all pages of this form. Select the form returned to the Requester | he "Accepted" on th | e Supplier Acceptance drop-down | . This will display the signature area. Digital | lly sign the declaration (if required by the | | | | |
| Supplier Digital Signature Ra | stislav Drska | Le | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|---------------------|------------------|--------|----------|-----------------|
| Die | 0.33 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.33 | mg |
| Die Attach 3.1 | 3.19 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 2.3925 | mg |
| | | | Supplier | Epoxy resins | 129915-35-1 | | 0.7975 | mg |
| Lead Frame 49.9 | 49.99 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.15 | mg |
| | | | Supplier | Magnesium (Mg) | 7439-95-4 | | 0.05 | mg |
| | | | Supplier | Silicon (Si) | 7440-21-3 | | 0.3499 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 1.4997 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 47.9404 | mg |
| Mold Compound-Black | 114.24 | mg | | Epoxy Phenol Resin | proprietary data | | 11.9952 | mg |
| | | | Supplier | Fused Silica (SiO2) | 60676-86-0 | | 102.2448 | mg |
| Plating | 6.7 | mg | Supplier | Tin (Sn) | 7440-31-5 | | 6.7 | mg |
| Wire Bond - Au | 0.65 | mg | Supplier | Gold (Au) | 7440-57-5 | | 0.65 | mg |